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Diodes Incorporated DMC3026LSD-13

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DMC3026LSD

COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

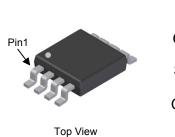
Device	V _{(BR)DSS}	R _{DS(ON)} max	l _D max T _A = +25°C
Q1 30V	301/	25mΩ @ V _{GS} = 10V	6.5A
	300	29mΩ @ V _{GS} = 4.5V	6.1A
Q2	-30V	28mΩ @ V _{GS} = -10V	-6.2A
		38mΩ @ V _{GS} = -4.5V	-5.3A

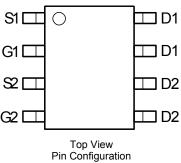
Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions
- Backlighting



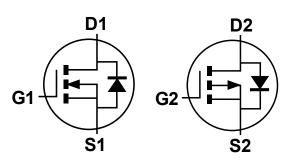


Features and Benefits

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.074 grams (approximate)



Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging	
DMC3026LSD-13	SO-8	2,500/Tape & Reel	

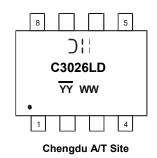
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

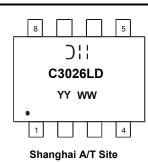
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





) | | = Manufacturer's Marking C3026LD = Product Type Marking Code YYWW = Date Code Marking YY or YY = Year (ex: 14 = 2014) WW = Week (01 - 53) YY = Date Code Marking for SAT (Shanghai Assembly/ Test site) YY = Date Code Marking for CAT (Chengdu Assembly/ Test site)



DMC3026LSD

Characteristic	Symbol	Q1	Q2	Units		
Drain-Source Voltage	V _{DSS}	30	-30	V		
Gate-Source Voltage	V _{GSS}	±20	±20	V		
	Steady State	T _A = +25°C T _A = +70°C	Ι _D	6.5 5.2	-6.2 -5.0	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t<10s	T _A = +25°C T _A = +70°C	Ι _D	8.2 6.7	-8.0 -6.5	А
Maximum Body Diode Forward Current (Note 6)		Is	2.2	-2.5	А	
Pulsed Drain Current (10µs pulse, duty cycle = 1	I _{DM}	40	-40	А		
Avalanche Current (Notes 7) L = 0.1mH	I _{AS}	14.5	22	А		
Avalanche Energy (Notes 7) L = 0.1mH			E _{AS}	10.5	25	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

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Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 5)	T _A = +25°C	Pn	1.2	W
Total Fower Dissipation (Note 5)	T _A = +70°C	PD	0.8	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	Devi	102	°C/W
memar Resistance, sunction to Ambient (Note 5)	t<10s	$R_{ hetaJA}$	62	
Total Power Dissipation (Note 6)	T _A = +25°C	Pn	1.6	W
Total Fower Dissipation (Note 0)	T _A = +70°C	FD	1.0	
Thermal Registeres, Junction to Ambient (Note 6)	Steady state	Devi	78	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	R _{0JA}	47	
Thermal Resistance, Junction to Case (Note 6)	Rejc	14.5		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics – Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)						÷	
Drain-Source Breakdown Voltage	BV _{DSS}	30	—		V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	—	—	1	μA	$V_{DS} = 24V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	—	±100	nA	V _{GS} = ±20V, V _{DS} = 0V	
ON CHARACTERISTICS (Note 8)						_	
Gate Threshold Voltage	V _{GS(th)}	1	—	3	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	
Static Drain-Source On-Resistance	P	_	19	25	m0	V _{GS} = 10V, I _D = 6A	
	R _{DS (ON)}	_	22	29	mΩ	V _{GS} = 4.5V, I _D = 5A	
Diode Forward Voltage	V _{SD}	_	0.7	1.2	V	V _{GS} = 0V, I _S = 1.3A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C _{iss}	_	641	—		V _{DS} = 15V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	Coss	_	66	—	pF		
Reverse Transfer Capacitance	C _{rss}	_	51	—			
Gate Resistance	R _G	_	2.2	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	6	—			
Total Gate Charge (V _{GS} = 10V)	Qg	_	13.2	_	nC	V _{DS} = 15V, I _D = 10A	
Gate-Source Charge	Q _{gs}	_	1.7				
Gate-Drain Charge	Q _{gd}	_	2.2				
Turn-On Delay Time	t _{D(on)}		3.3			V _{GS} = 10V, V _{DD} = 15V, R _G = 6Ω,	
Turn-On Rise Time	tr		4.4		nS		
Turn-Off Delay Time	t _{D(off)}		22.3		115	I _D = 1A	
Turn-Off Fall Time	tf	_	5.3	_			

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. Notes:

Device mounted on FR-4 substrate PC board, 202 copper, with hinhmun recommended parts.
 Device mounted on FR-4 substrate PC board, 202 copper, with hinhmun recommended parts.
 UIS in production with L = 0.1mH, starting T_A = +25°C.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.

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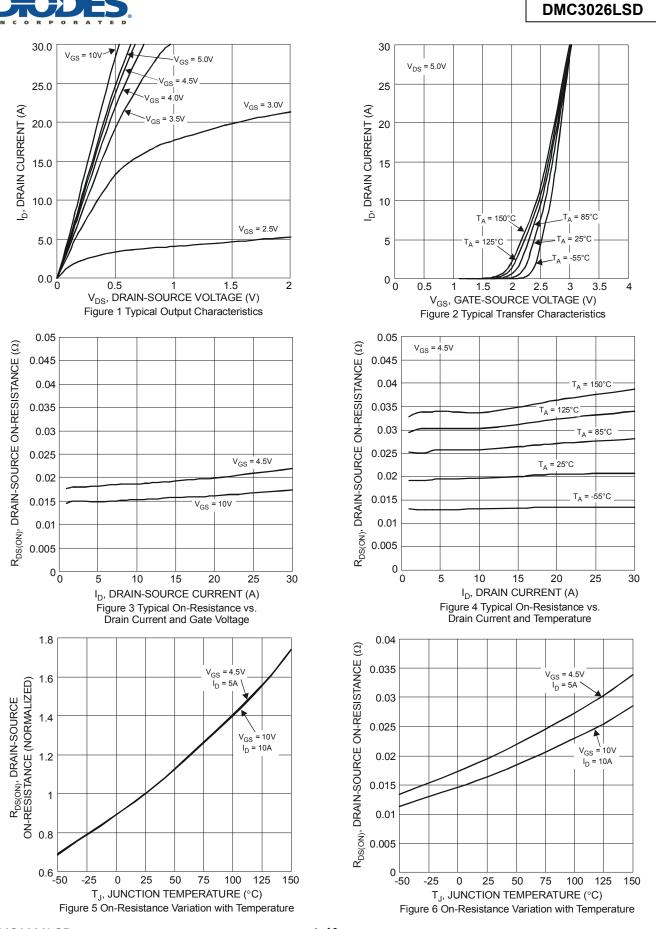
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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	—	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μA	$V_{DS} = -24V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_		±100	nA	V_{GS} = ±20V, V_{DS} = 0V
ON CHARACTERISTICS (Note 8)						
Gate Threshold Voltage	V _{GS(th)}	-1	_	-3	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance	Р	_	21	28		V _{GS} = -10V, I _D = -6A
Static Drain-Source On-Resistance	R _{DS(ON)}	_	29	38	mΩ	V_{GS} = -4.5V, I_{D} = -5A
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	V _{GS} = 0V, I _S = -1.3A
DYNAMIC CHARACTERISTICS (Note 9)						
Input Capacitance	C _{iss}	_	1241	—		V _{DS} = -15V, V _{GS} = 0V f = 1.0MHz
Output Capacitance	C _{oss}	_	146	—	pF	
Reverse Transfer Capacitance	C _{rss}	_	110			
Gate Resistance	R _G	_	14.8		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	10.9	_		
Total Gate Charge (V _{GS} = -10V)	Qg	_	22	_	-	V _{DS} = -15V, I _D = -7A
Gate-Source Charge	Q _{gs}	_	3.5	_	nC	
Gate-Drain Charge	Q _{gd}	_	4.7	_		
Turn-On Delay Time	t _{D(on)}		9.7	_		
Turn-On Rise Time	tr		17.1	_	nS	V_{GS} = -10V, V_{DD} = -15V, R_{GEN} = 6 Ω
Turn-Off Delay Time	t _{D(off)}		60.5	—	ns	I _D = -7A
Turn-Off Fall Time	tr	_	40.4	_	1	

Notes: 8. Short duration pulse test used to minimize self-heating effect.

9. Guaranteed by design. Not subject to product testing.



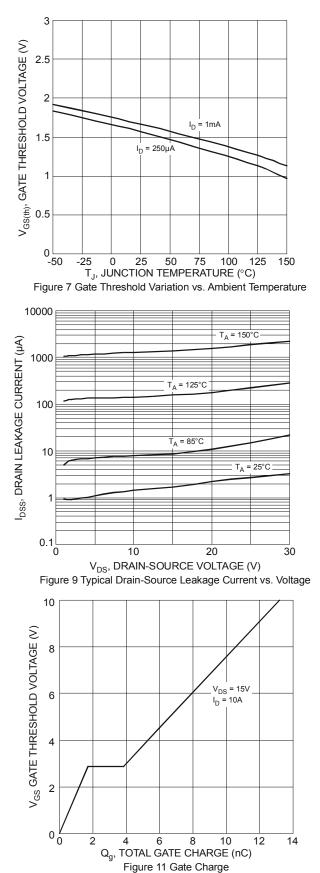


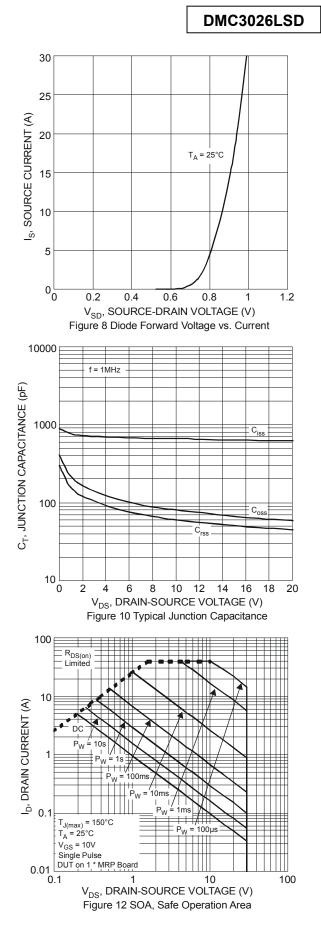
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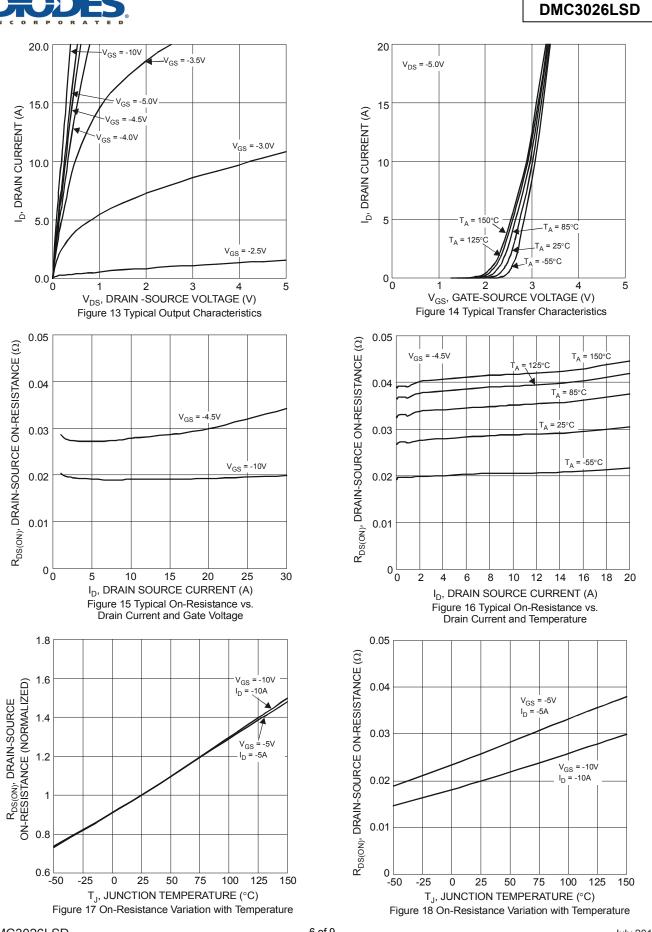






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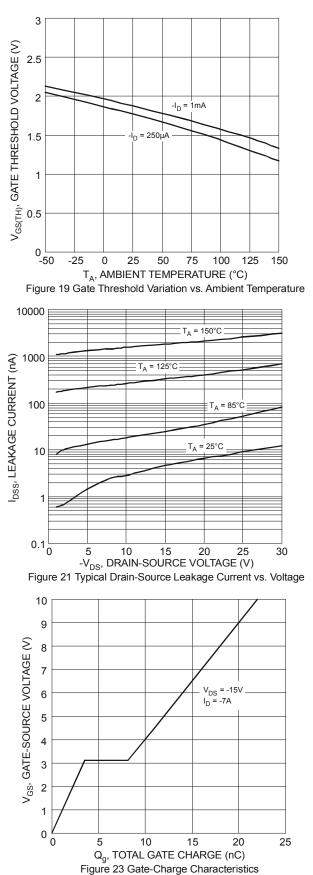
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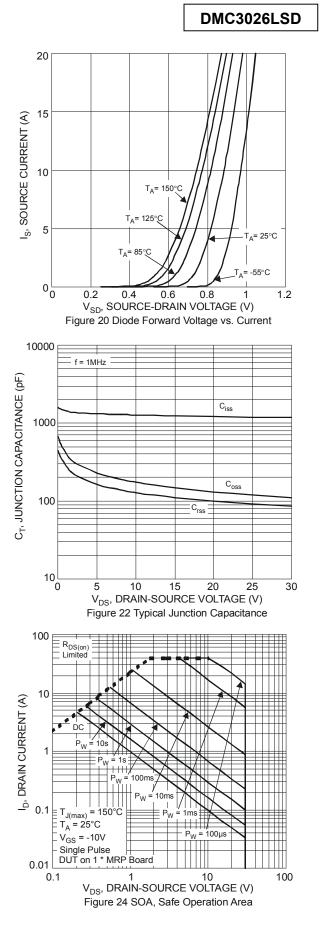
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NEW PRODUCT

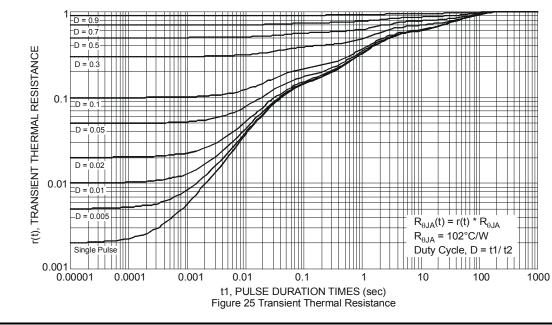
Distributor of Diodes Incorporated: Excellent Integrated System Limited Datasheet of DMC3026LSD-13 - MOSFET N/P-CH 30V 6.5A/6.2A 8SO Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com





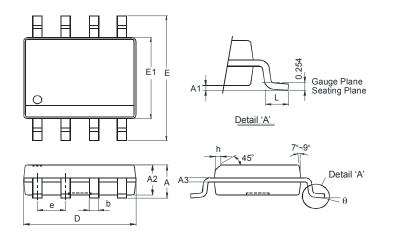


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Package Outline Dimensions

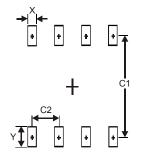
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



	SO-8						
Dim	Min	Max					
Α	-	1.75					
A1	0.10	0.20					
A2	1.30	1.50					
A3	0.15	0.25					
b	0.3	0.5					
D	4.85	4.95					
ш	5.90	6.10					
E1	3.85	3.95					
е	1.27 Typ						
h	-	0.35					
L	0.62	0.82					
θ	0°	8°					
All Di	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Y	1.55
C1	5.4
C2	1.27

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